

USB365A - Preliminary 3.3-4.0GHz USB Series TDD BPF

Features

- Low Loss with High Rejection
- Universal footprint across family for all TDD bands

Applications

- Wireless Infrastructure applications
- High-performance carrier-grade TDD Pico-cells.



Materials: Ag plated ceramic block with tin plated brass soield

Description

Surface mount ceramic bandpass filter supports a universal footprint across all TDD frequency bands enabling the use of a common system PCB. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared to other bandpass filter technologies.

Electrical Specifications

Parameter	Frequency (MHz)	Typical at 25°C	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	8.0 Watt max
Peak Input Power	-	-	-	80 Watt max
Input-Output Response				
Passband Insertion Loss (100 MHz avg)	3300-4000		1.0-1.2 dB max	1.0-1.2 dB max
Passband Ripple	3300-4000		<0.8 dB max	<0.9 dB max
Passband Return Loss	3300-4000		10-11 dB min	10-11 dB min
Attenuation:	1-2700		45 dB min	45 dB min
	4700-4799		35 dB min	35 dB min
	4800-5600		40 dB min	40 dB min
	5601-7000		40dB min EST	40 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances. Specification Allowance Insertion Loss 0.1 dB Return Loss 1.0 dB Attenuation 1.0 dB

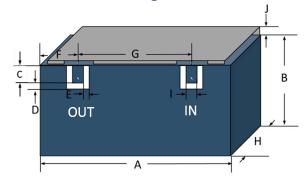
2020-09-22 Rev. A WWW.ctscorp.com Page 1 of 2



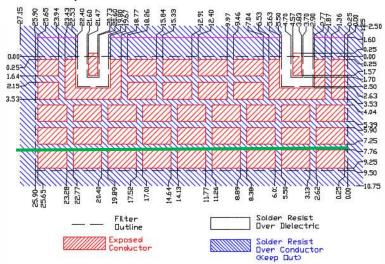
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Mechanical Drawing



PCB Layout



Dim.	Nominal (mm)	Tolerance	
Α	25.40	0.30	
В	<4.50	0.30	
С	1.70	0.13	
D	0.40	0.13	
Е	0.80	0.13	
F	4.20	0.13	
G	16.90	0.13	
Н	6.40	0.30	
1	1.00	0.13	
J	1.10	0.20	

IMPORTANT: Please assure >=30mils (0.75mm) thickness of dielectric beneath the I/O Pads \underline{and} the surrounding clearance zone down to the ground plane.

Please assure sufficient ground vias between the top metal ground plane and the primary ground plane.

Recommended solder: 4-6 mils of SAC305 with reflow including 120s of soak at 217°C, and up to 30 sec peak at 241°C.

NOTE: The width of 9.50mm is necessary to support frequencies as low as 1885MHz for Band 39. The width of 7.60mm is necessary to support frequencies as low as 2496MHz for Band 41. If only higher frequency TDD bands are supported, then a smaller space can be allocated on the layout.

Packaging and Marking

Dimensi	on Units	s Spec.	Product Product	: Marking
Reel Diame		330		CTS 165
Reel Weig	ht kg	5.5		
Reel Quan	tity ea.	500	YV	WW
PoMM/(Inches)	Customer Fe	AO MM/(Inche	Wo MM/(Inches)	Bo MM/(Incl — Ko MM/(Inches)
W_{o}	Ao	Bo	Ko	Po
1.732 in	0.236 in	1.028 in	0.283 in	0.472 in

44.0 mm 6.00 mm 26.10 mm 7.20 mm

Electrical Response

